05-03-200	Atty. Docket No.: 2019-0256PUS1 Page 1 of 1	
	II (0) II (II)	
10273543 Please record the attached or	9 . ademark Office: ක්රි riginal documents or copy thereof.	
1. Name of conveying party(ies): [FAMILY NAME (ALL CAPS), Given Name] CHIEN, Ray HUANG, Honda , , , Additional name(s) of conveying party(ies) attached?	2. Name and address of receiving party(ies) Name: VIA TECHNOLOGIES, INC. Internal Address: Street Address: 8F, No. 533, Chung Cheng Rd., Hsin Tien City City: Taipei Hsien State: ZIP: Country: Taiwan, R.O.C. Postal Code: Additional name(s) & address(es) attached? YES NO	
	32290 the execution data of the application is: Appli 21, 2004	
A. Patent Application No(s). NEW	B. Patent No.(s).	
Additional numbers att: 5. Name and address of party to whom correspondence concerning document should be mailed: Name: BIRCH, STEWART, KOLASCH & BIRCH, LLP	ached?	
Street Address: P.O. BOX 747 City: FALLS CHURCH State: VA ZIP: 22040-0747 Country: USA	Authorized to be charged to deposit account, if no fee attached. 8. Deposit account number: 02-2448 (Attach triplicate copy of this page	
DO NOT US 9. Statement and signature.	if paying by deposit account) SE THIS SPACE	
Joe McKinney Muncy, #32,334 Name of Person Signing/Reg. No.	April 27, 2004 Signature Date	
Total number of pages including cover sheet, attachments, and document: Three (3)		

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(Rev. 02/12/2004)

BIRCH, STEWART, KOLASCH & BIRCH, LLP

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ASSIGNMENT

	Application No. NEW	Filed April 27, 2004	
Insert Name(s of Inventor(s)) ***(FAMILY NAME (ALL CA	PS), Given Name)***	
	WHEREAS, RAY CHIEN	; HONDA HUANG	
		· · · · · · · · · · · · · · · · · · ·	
		<u></u>	
	·		
	;	<u> </u>	
Insert Title	(hereinafter designated as the undersigned) has (have)	invented certain new and useful improvements in	
of Invention	SOI SINGLE CRYSTALLINE CHIP STRUCTURE	,	
Insert Date of Signing of Application Insert Name of Assignce	for which an application for Letters Patent of the Undersigned (except in the case of a provisional application on APRIL 21, 2004 WHEREAS, VIA TECHNOLOGIES, INC.	<u> </u>	
Insert Address of Assignee	of 8F, NO. 533, CHUNG CHENG RD., HSIN TIE	N CITY, TAIPEI HSIEN, TAIWAN, R.O.C.	
CHECK BOX IF APPROPRIATE	its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and in any foreign countries.		
	NOW, THEREFORE, in consideration of the sum of Te the receipt of which is hereby acknowledged, and othe has (have) sold, assigned and transferred, and by thes Assignee the full and exclusive right to the said invent dependencies and possessions and the entire right, title which may be granted therefor in the United State possessions, and if the box above is designated, in any and	r good and valuable consideration, the undersigned e presents does sell, assign and transfer unto said ion in the United States of America, its territories, and interest in and to any and all Letters Patent(s) es of America, its territories, dependencies and	
	and to any and all divisions, reissues, continuations, conterms for which the same may be granted.	versions and extensions thereof for the full term or	

Page I of 2

PATENT REEL: 015269 FRAME: 0720 The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date APRIL 21, 2004	Name of Inventor	RAY CHIEN (FAMILY NAME: CHIEN)
Date APRIL 21, 2004	(signature)	- Honda Huang (Family Name: Huang)
Date,		·
Date,		
Date,	Name of Inventor (signature)	
Date,	Name of Inventor (signature)	
Page 2 of <u>2</u> .		

RECORDED: 04/27/2004

January 2002

PATENT REEL: 015269 FRAME: 0721